



TECHNICAL BULLETIN

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FA-A-0339-A

## Change in the Packaging of MELSEC iQ-R Series Products (Manufactured in and after July 2021)

■Date of Issue

July 2021

■Relevant Models

R04CPU, R08CPU, R16CPU, R32CPU, R120CPU, R08PCPU, R16PCPU, R32PCPU, R120PCPU, RX10, RX10-TS, RX28, RX40C7, RX40C7-TS, RX41C4-TS, RX70C4, RX40PC6H, RX40NC6H, RX40NC6B, RY10R2, RY10R2-TS, RY18R2A, RY20S6, RY40NT5P, RY40PT5P, RY40NT5P-TS, RY41NT2P-TS, RY40PT5P-TS, RY41PT1P-TS, RY40PT5B, RY40PT5B-AS, R60ADI8, R60ADV8, R60ADH4, R60ADI8-HA, R60DA4, R60DAI8, R60DAV8, R60DAH4, R60TD8-G, RD60P8-G, RD81MES96N, RD81OPC96

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Thank you for your continued support of Mitsubishi Electric programmable controllers.

We are informing you of the change in the packaging of some MELSEC iQ-R series products.

There is no impact on the product functions and performance due to this change.

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## 1 TARGET MODELS AND BOX SIZE

Target model		Box size	
Product	Model	Before change	After change
Programmable controller CPU	R04CPU	160 (W) × 147 (D) × 47 (H) [mm]	126 (W) × 156 (D) × 47 (H) [mm]
	R08CPU		
	R16CPU		
	R32CPU		
	R120CPU		
Process CPU	R08PCPU		
	R16PCPU		
	R32PCPU		
	R120PCPU		
AC input module	RX10		
	RX10-TS		
	RX28		
DC input module	RX40C7		
	RX40C7-TS		
	RX41C4-TS		
	RX70C4		
DC high-speed input module	RX40PC6H		
	RX40NC6H		
Input module with diagnostic functions	RX40NC6B		
Contact output module	RY10R2		
	RY10R2-TS		
	RY18R2A		
Triac output module	RY20S6		
Transistor output module	RY40NT5P		
	RY40PT5P		
	RY40NT5P-TS		
	RY41NT2P-TS		
	RY40PT5P-TS		
	RY41PT1P-TS		
Output module with diagnostic functions	RY40PT5B		
SIL2 analog control output module	RY40PT5B-AS		
Analog-digital converter module	R60ADI8		
	R60ADV8		
High speed analog-digital converter module	R60ADH4		
HART-enabled analog-digital converter module	R60ADI8-HA		
Digital-analog converter module	R60DA4		
	R60DAI8		
	R60DAV8		
High speed digital-analog converter module	R60DAH4		
Channel isolated thermocouple input module	R60TD8-G		
Channel isolated pulse input module	RD60P8-G		
MES interface module	RD81MES96N		
OPC UA server module	RD81OPC96		

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The following shows the external appearance and materials before and after change.

Before change	After change
 <p>The words of MELSEC iQ-R series are printed.</p>	 <p>The words of MELSEC iQ-R series are not printed.</p>
 <p>Cardboard (outer packaging) + molded pulp (two pieces of inner packaging)</p>	 <p>Cardboard (outer packaging)</p>

## 2 REASON FOR THE CHANGE

Buffer materials are changed to cardboard in compliance with ISO 14001 (environmental management) to reduce environmental burden.

## 3 DATE OF CHANGE

The change applies to products manufactured in and after July 2021.

Note that, depending on stock status, both the old and new boxes may be distributed in the market around that time.

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**REVISIONS**

Version	Date of Issue	Revision
A	July 2021	First edition

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